MRP 822

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R SHEET

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To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof

	Name of conveying party(ies):	2. Name and address of receiving party(ies): 2
	Graham Kirsch 09/642781	Name: Micron Technology
	Additional name(s) of conveying Yes	Internal Address:
	party(ies) attached?	Street Address: Micron Technology, Inc. 8000 S. Federal Way
	3. Nature of Conveyance:	,
	x Assignment Merger	City: Boise
	Security Agreement Change of Name	State: <u>Idaho</u> Zip: <u>83707-0006</u>
	Other	Country: US
	Execution Date(s): August 6, 2000	Additional name(s) & Yes address(es) attached? X No
	4. Application number(s) or patent number(s):	
	If this document is being filed together with a new application, the Execution date(s) of the new application is (are): August 6, 2000	
	A. Patent Application No.(s):	B. Patent No.(s):
		Additional numbers attached? Yes X No
	5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
	Name: DICKSTEIN SHAPIRO MORIN & OSHINSKY LLP	7. Total fee (37 C.F.R 3.41) \$\$40.00
	Internal Address: Atty. Dkt.: M4065.0342/P342	x Enclosed
	Attn: Thomas J. D'Amico	Authorized to be charged to deposit account
	Street Address: 2101 L Street NW	Credit any overpayment or debit any underpayment
08/30/2000 PSTA	NBAC 0000045 09642781 State: Zip:	8. Deposit account number: 4 - 1073
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	9. Statement and signature.	
	To the best of my knowledge and belief, the foreg copy is a true copy of the original document.	oing information is true and correct and any attached
	Thomas J. D'Amico	August 22, 2000
	Signature	Date
	Reg. No. 28,371	
	Total number of pages including cover sheet, attachments, and document: 3	

PATENT

REEL: 011031 FRAME: 0382

Docket No.: M4065.0342/P342 Micron No.: 99-1245

ASSIGNMENT AND AGREEMENT

For value received, I, Graham Kirsch hereby sell, assign and transfer to Micron Technology, Inc., a corporation of the State of Delaware, having an office at 8000 S. Federal Way, Boise, Idaho 83706-9632, U.S.A., and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to an invention entitled METHOD OF CONSTRUCTING A VERY WIDE, VERY FAST, DISTRIBUTED MEMORY, described in an application for Letters Patent of the United States, executed by me of even date herewith, and all the rights and privileges in said application and under any and all Letters Patent that may be granted in the United States for said inventions; and I also concurrently hereby sell, assign and transfer to Micron Technology, Inc. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

I authorize Micron Technology, Inc. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from me, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

I hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Micron Technology, Inc. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

I request that any and all patents for said inventions be issued to Micron Technology, Inc. in the United States and in all countries foreign to the United States, or to such nominees as Micron Technology, Inc. may designate.

1170461 v1; P34T01!.DOC 1170461 v1; P34T01!.DOC

> PATENT REEL: 011031 FRAME: 0383

Docket No.: M4065.0342/P342 Micron No.: 99-1245

I agree that, when requested, I shall, without charge to Micron Technology, Inc. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

Date: 6 Augustion

Graham Kirsch

Witnesses:

Date: 6/8/00

Date: 6/8/2000

R.M. BEANT